MOSFET - SiC Power, Single N-Channel 1200 V, 40 mΩ, 60 A

NVHL040N120SC1

Features

- Typ. $R_{DS(on)} = 40 \text{ m}\Omega$
- Ultra Low Gate Charge (typ. $Q_{G(tot)} = 106 \text{ nC}$)
- Low Effective Output Capacitance (typ. Coss = 140 pF)
- 100% UIL Tested
- Qualified According to AEC-Q101
- These Devices are RoHS Compliant

Typical Applications

- Automotive On Board Charger
- Automotive DC/DC converter for EV/HEV

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V _{DSS}	1200	V
Gate-to-Source Voltage			V _{GS}	-15/+25	V
Recommended Operation Values of Gate-to-Source Voltage	T _C < 175°C		V_{GSop}	-5/+20	٧
Continuous Drain Current $R_{\theta JC}$	Steady State	T _C = 25°C	I _D	60	Α
Power Dissipation $R_{\theta JC}$			P_{D}	348	W
Continuous Drain Current R _{0JC}	Steady State	T _C = 100°C	I _D	42	Α
Power Dissipation $R_{\theta JC}$			P_{D}	174	W
Pulsed Drain Current (Note 2)	T _A = 25°C		I _{DM}	240	Α
Single Pulse Surge Drain Current Capability	T _A = 25°0 R _G	C, t _p = 10 μs, = 4.7 Ω	I _{DSC}	416	Α
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +175	°C
Source Current (Body Diode)			Is	34	Α
Single Pulse Drain-to-Source Avalanche Energy (I _{L(pk)} = 23 A, L = 1 mH) (Note 3)			E _{AS}	613	mJ

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit	
Junction-to-Case (Note 1)	$R_{\theta JC}$	0.43	°C/W	
Junction-to-Ambient (Note 1)	$R_{\theta JA}$	40	°C/W	

- The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.
- 2. Repetitive rating, limited by max junction temperature.
- 3. E_{AS} of 613 mJ is based on starting T_J = 25°C; L = 1 mH, I_{AS} = 35 A, V_{DD} = 120 V, V_{GS} = 20 V.

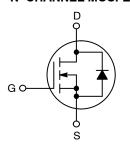


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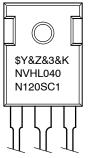
V _{(BR)DSS}	R _{DS(on)} MAX	I _D MAX
1200 V	56 mΩ @ 20 V	60 A

N-CHANNEL MOSFET





MARKING DIAGRAM



\$Y = ON Semiconductor Logo &Z = Assembly Plant Code &3 = Data Code (Year & Week)

&K = Lot

NVHL040N120SC1 = Specific Device Code

ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

ELECTRICAL CHARACTERISTICS

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
OFF CHARACTERISTICS						ı
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0 V, I _D = 1 mA	1200	_	-	V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J	I _D = 1 mA, referenced to 25°C	-	450	-	mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V, V _{DS} = 1200 V, T _J = 25°C	_	-	100	μА
		V _{GS} = 0 V, V _{DS} = 1200 V, T _J = 175°C	_	-	250	
Gate-to-Source Leakage Current	I _{GSS}	V _{GS} = +25/–15 V, V _{DS} = 0 V	-	-	±1	μΑ
ON CHARACTERISTICS						
Gate Threshold Voltage	V _{GS(th)}	$V_{GS} = V_{DS}$, $I_D = 10 \text{ mA}$	1.8	2.97	4.3	V
Recommended Gate Voltage	V _{GOP}		-5	-	+20	V
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 20 V, I _D = 35 A, T _J = 25°C	_	39	56	mΩ
		V _{GS} = 20 V, I _D = 35 A, T _J = 175°C	-	67	100	=
Forward Transconductance	9FS	V _{DS} = 20 V, I _D = 35 A	_	20	-	S
CHARGES, CAPACITANCES & GATE	RESISTANCE					•
Input Capacitance	C _{ISS}	V _{GS} = 0 V, f = 1 MHz, V _{DS} = 800 V	-	1781	-	pF
Output Capacitance	C _{OSS}		-	140	_	•
Reverse Transfer Capacitance	C _{RSS}		_	12	_	1
Total Gate Charge	Q _{G(tot)}	$V_{GS} = -5/20 \text{ V}, V_{DS} = 600 \text{ V}, I_D = 47 \text{ A}$	_	106	_	nC
Threshold Gate Charge	Q _{G(th)}		_	16	-	1
Gate-to-Source Charge	Q _{GS}		_	34	_	
Gate-to-Drain Charge	Q _{GD}	-	_	26	-	-
Gate Resistance	R _G	f = 1 MHz	_	2.2	_	Ω
SWITCHING CHARACTERISTICS				ı		ı
Turn-On Delay Time	t _{d(on)}	$V_{GS} = -5/20 \text{ V}, V_{DS} = 800 \text{ V},$	_	18	_	ns
Rise Time	t _r	$I_D = 47 \text{ A}, R_G = 4.7 \Omega,$ Inductive Load	_	41	_	
Turn-Off Delay Time	t _{d(off)}	Illiadouvo Loda	_	33	_	
Fall Time	t _f	-	_	10.4	_	
Turn-On Switching Loss	E _{ON}	-	_	1003	_	μJ
Turn-Off Switching Loss	E _{OFF}	-	_	247	_	† `
Total Switching Loss	E _{TOT}	-	_	1248	_	-
DRAIN-SOURCE DIODE CHARACTEI						
Continuous Drain-to-Source Diode Forward Current	I _{SD}	$V_{GS} = -5 \text{ V}, T_J = 25^{\circ}\text{C}$	-	_	34	Α
Pulsed Drain-to-Source Diode Forward Current (Note 2)	I _{SDM}	V _{GS} = -5 V, T _J = 25°C	-	-	240	А
Forward Diode Voltage	V _{SD}	V _{GS} = -5 V, I _{SD} = 17.5 A, T _J = 25°C	_	3.8	-	V
Reverse Recovery Time	t _{RR}	$V_{GS} = -5/20 \text{ V}, I_{SD} = 47 \text{ A},$	_	24	-	ns
Reverse Recovery Charge	Q _{RR}	dl _S /dt = 1000 A/μs	_	125	-	nC
Reverse Recovery Energy	E _{REC}	1	_	8.5	_	μJ
Peak Reverse Recovery Current	I _{RRM}	1	_	10.4	_	A
Charge Time	ta	†	_	12.4	_	ns
Discharge Time	t _b	†	_	11.6	_	ns
-	_ ~			1		<u> </u>

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL CHARACTERISTICS

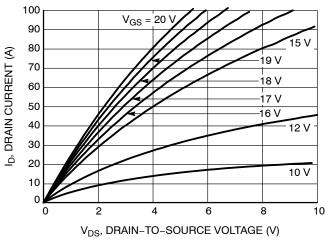


Figure 1. On-Region Characteristics

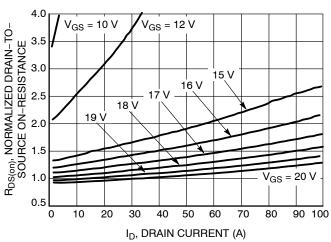


Figure 2. Normalized On-Resistance vs. Drain Current and Gate Voltage

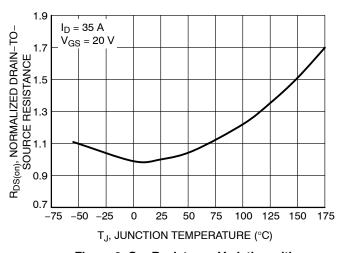


Figure 3. On–Resistance Variation with Temperature

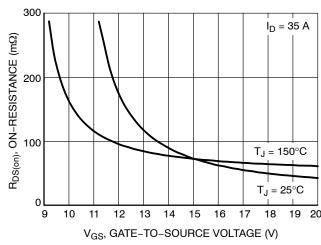


Figure 4. On-Resistance vs. Gate-to-Source Voltage

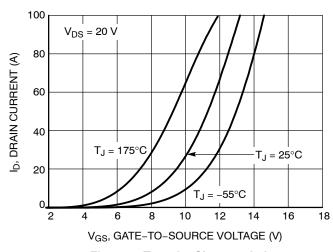


Figure 5. Transfer Characteristics

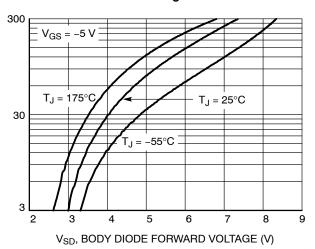


Figure 6. Diode Forward Voltage vs. Current

REVERSE DRAIN CURRENT (A)

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TYPICAL CHARACTERISTICS

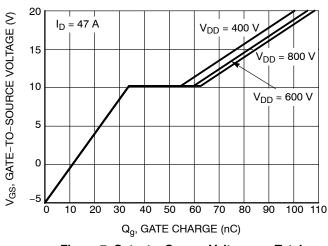


Figure 7. Gate-to-Source Voltage vs. Total Charge

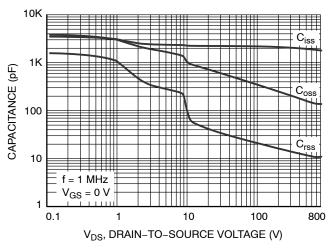


Figure 8. Capacitance vs. Drain-to-Source Voltage

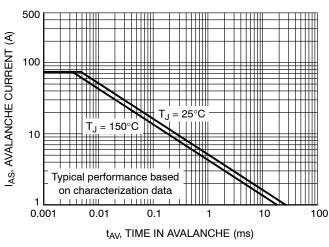


Figure 9. Unclamped Inductive Switching Capability

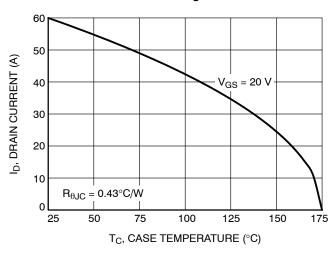


Figure 10. Maximum Continuous Drain Current vs. Case Temperature

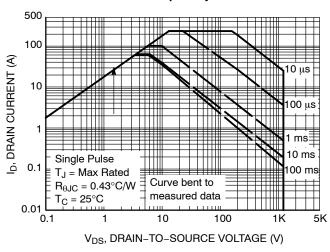


Figure 11. Safe Operating Area

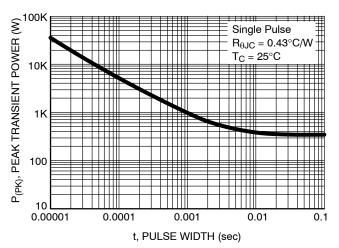


Figure 12. Single Pulse Maximum Power Dissipation

TYPICAL CHARACTERISTICS

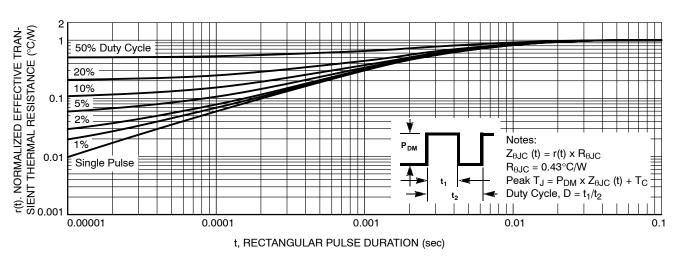


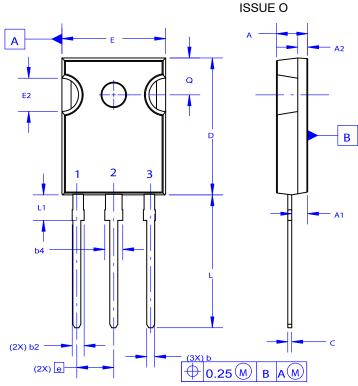
Figure 13. Junction-to-Ambient Thermal Response

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Marking	Package	Packing Method	Reel Size	Tape Width	Quantity
NVHL040N120SC1	NVHL040N120SC1	TO-247 Long Lead	Tube	N/A	N/A	30 Units

PACKAGE DIMENSIONS

TO-247-3LD CASE 340CX

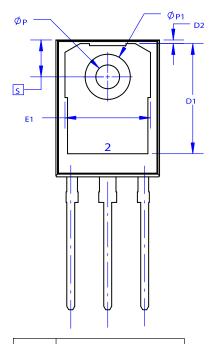


NOTES: UNLESS OTHERWISE SPECIFIED.

- A. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.

 B. ALL DIMENSIONS ARE IN MILLIMETERS.

- C. DRAWING CONFORMS TO ASME Y14.5 2009.
 D. DIMENSION A1 TO BE MEASURED IN THE REGION DEFINED BY L1.
- E. LEAD FINISH IS UNCONTROLLED IN THE REGION DEFINED BY L1.



DIM	MILLIMETERS				
DIM	MIN	NOM	MAX		
Α	4.58	4.70	4.82		
A 1	2.20	2.40	2.60		
A2	1.40	1.50	1.60		
D	20.32	20.57	20.82		
Е	15.37	15.62	15.87		
E2	4.96	5.08	5.20		
е	~	5.56	~		
L	19.75	20.00	20.25		
L1	3.69	3.81	3.93		
ØΡ	3.51	3.58	3.65		
Q	5.34	5.46	5.58		
S	5.34	5.46	5.58		
b	1.17	1.26	1.35		
b2	1.53	1.65	1.77		
b4	2.42	2.54	2.66		
С	0.51 0.61		0.71		
D1	13.08	~	~		
D2	0.51	0.93	1.35		
E1	12.81	12.81 ~ ~			
ØP1	6.60	6.80	7.00		

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